

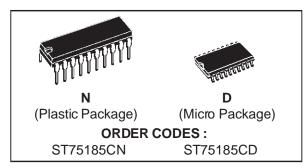
## MULTIPLE RS-232 DRIVERS AND RECEIVERS

- MEETS AND EXCEEDS THE REQUIREMENTS OF EIA/TIA-232-E AND ITUV.28 STANDARD
- SINGLE CHIP WITH EASY INTERFACE BETWEEN UART AND SERIAL PORT CONNECTOR OF IBM PC/AT™ AND COMPATIBLES
- DESIGNED TO SUPPORT DATA RATES UP TO 120 Kbps
- PINOUT COMPATIBLE WITH ST75C185

#### **DESCRIPTION**

The ST75185 contains three drivers and five receivers. The pinout matches the DB9S connector design in order to decrease the part count, reduce the board space required and allow easy interconnection of the UART and serial port connector of IBM PC/AT™ and compatibles. The bipolar circuits and processing of the ST75185 provides a rugged low-cost solution for this function at the expense of quiescent power and external passive components relative to the ST75C185.

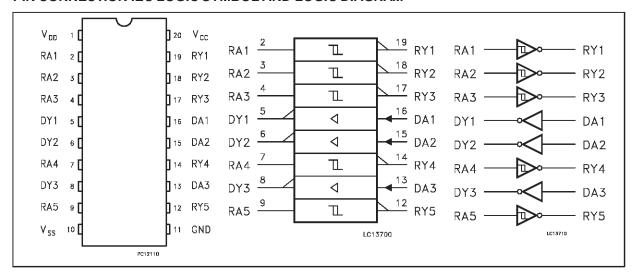
The ST75185 complies with the requirements of the EIA/TIA 232-E and ITU (formally CCITT) v.28



standards. These standards are for data interchange between a host computer and peripheral at signalling rates up to 20k-bits/s. The switching speeds of the ST75185 are fast enough to support rates up to 120K-bits/s with lower capacitive loads (shorter cables). Interoperability at the higher signalling rates cannot be assured unless the designer has design control of the cable and the interface circuits at the both ends. For interoperability at signalling rates to 120 K-bits/s, use of EIA/ITA-423-B (ITU v.10) and EIA/ITA-422-B (ITU v.11) standards are recommended.

The ST75185 is characterized for operation over the range of  $0^{\circ}$ C to  $70^{\circ}$ C.

#### PIN CONNECTION IEC LOGIC SYMBOL AND LOGIC DIAGRAM



June 2000 1/12

#### **ORDER CODES**

Туре	Temperature Range	Package	Comments
ST75185CN	0 to 70 °C	DIP-20	20 parts per tube / 50 tubes per box
ST75185CD	0 to 70 °C	SO-20 (Tube)	40 parts per tube / 25 tubes per box
ST75185CDR	0 to 70 °C	SO-20 (Tape & Reel)	1000 parts per reel

#### **PIN DESCRIPTION**

PIN No	SYMBOL	NAME AND FUNCTION
1	V <sub>DD</sub>	Supply Voltage (+12V)
2	RA1	First Receiver Input
3	RA2	Second Receiver Input
4	RA3	Third Receiver Input
5	DY1	First Driver Output
6	DY2	Second Driver Output
7	RA4	FourthReceiver Input
8	DY3	Third Driver Output
9	RA5	Fifth Receiver Input
10	V <sub>SS</sub>	Supply Voltage (-12V)
11	GND	Ground
12	RY5	Fifth Receiver Output
13	DA3	Third Driver Input
14	RY4	Fourth Receiver Output
15	DA2	Second Driver Input
16	DA1	First Driver Input
17	RY3	Third Receiver Output
18	RY2	Second Receiver Output
19	RY1	First Receiver Output
20	V <sub>CC</sub>	Supply Voltage (+5V)

#### ABSOLUTE MAXIMUM RATINGS OVER OPERATING FREE-AIR TEMPERATURE RANGE

(unless otherwise specified)

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage (Note 1)	15	V
V <sub>SS</sub>	Supply Voltage (Note 1)	-15	V
Vcc	Supply Voltage (Note 1)	10	V
VI	Input Voltage Range (DRIVER)	-15 to 7	V
VI	Input Voltage Range (RECEIVER)	-30 to 30	V
Vo	Output Voltage Range (DRIVER)	-15 to 15	V
Io	Receiver Low Level Output Current	20	mA
P <sub>D</sub>	Continuous Total Power Dissipation	See Dissipation Rating Table	
T <sub>A</sub>	Operating Free-Air Temperature Range	0 to 70	°C
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C
T∟	Lead Temperature 1.6mm from case for 10 sec	260	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied. NOTE1:All voltage are with respect to the network ground terminal.

#### **DISSIPATION RATING TABLE**

Package	Power Rating at $T_A \le$ 25 $^{\circ}C$	Derating Factor above T <sub>A</sub> = 25 °C (*)	Power Rating at $T_A \le 70$ °C
MICROPACKAGE (D)	1125 mW	9.0 mW/°C	720 mW
DIP (N)	1150 mW	9.2 mW/°C	736 mW

<sup>(\*)</sup> This is the reverse of the traditional junction-case thermal resistance R<sub>tJ-C</sub>

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Parameter			Unit
$V_{DD}$	Supply Voltage		7.5	15	V
V <sub>SS</sub>	Supply Voltage		-7.5	-15	V
Vcc	Supply Voltage		4.5	5.5	V
V <sub>IN</sub>	Driver Input Voltege		0	V <sub>CC</sub>	V
I <sub>OH</sub>	High Level Output Current	DRIVER		-6	mA
		RECEIVER		-0.5	
I <sub>OL</sub>	Low Level Output Current	DRIVER		6	mA
		RECEIVER		16	
T <sub>A</sub>	Operating Free-Air Temperature		0	70	°C

#### **SUPPLY CURRENTS**

Symbol	Parameter	Т	est Con	ditions		Value		Unit
		V <sub>DD</sub>	V <sub>SS</sub>		Min.	Тур.	Max.	
I <sub>DD</sub>	Supply Current from V <sub>DD</sub>	9	-9	No load.			15	
		12	-12	All inputs at			19	mΑ
		15	-15	1.9V			25	
		9	-9	No load.			4.5	mA
		12	-12	All inputs at			5.5	
		15	-15	0.8V			9	
I <sub>SS</sub>	Supply Current from V <sub>SS</sub>	9	-9	No load.			-15	
		12	-12	All inputs at			-19	mΑ
		15	-15	1.9V			-25	
		9	-9	No load.			-3.2	mA
		12	-12	All inputs at			-3.2	
		15	-15	0.8V			-3.2	
Icc	Supply Current from V <sub>CC</sub>	No I	oad. All ir V <sub>CC</sub> =	nputs at 5V : 5V			30	mA

#### DRIVER ELECTRICAL CHARACTERISTICS OVER OPERATING FREE-AIR TEMPERATURE

**RANGE** ( $V_{DD} = 9V$ ,  $V_{SS} = -9V$ ,  $V_{CC} = 5V$ , unless otherwise specified)

Symbol	Parameter	Test Conditions	Value		Unit	
			Min.	Тур.	Max.	
V <sub>OH</sub>	High Level Output Voltage	$V_{IL} = 0.8 \text{ V}$ $R_L = 3K\Omega$ (See Figure 1)	6	7.5		V
VoL	Low Level Output Voltage (Note 3)	$V_{IH} = 1.9 \text{ V}$ $R_L = 3K\Omega$ (See Figure 1)		-7.5	-6	V
I <sub>IH</sub>	High Level Input Current	V <sub>I</sub> = 5 V (See Figure 2)			10	μΑ
I <sub>IL</sub>	Low Level Input Current	V <sub>I</sub> = 0 V (See Figure 2)			-1.6	mA
I <sub>OS(H)</sub>	High Level Short Circuit Output Current (Note 4)	$V_{IL} = 0.8 \text{ V}  V_O = 0 \text{ V}$ (See Figure 1)	-4.5	-12	-19.5	mA
I <sub>OS(L)</sub>	Low Level Short Circuit Output Current	$V_{IH} = 2 \text{ V}  V_O = 0 \text{ V}$ (See Figure 1)	4.5	12	19.5	mA
Ro	Output Resistance	$V_{DD} = V_{SS} = V_{CC} = 0 \text{ V}$ $V_{O} = -2 \text{ to } 2 \text{ V} \text{ (Note 5)}$	300			Ω

NOTE 3: The algebraic convention, where the more positive (less negative) limitis designated as maximum, is used in this datasheet for logic levels only (e.g. if -10V is a maximum, the typical value is a more negative voltage).

NOTE 4: Output short circuit conditions must a marain the total power dissipation below absolute maximum ratings.

NOTE 5: Test conditions are those specified by EIA-232-E and as listed above.

57 4/12

#### **DRIVER SWITCHING CHARACTERISTICS**

 $(V_{DD} = 12V, V_{SS} = -12V, V_{CC} = 5V T_A = 25 \, ^{\circ}C)$ 

Symbol	Parameter	Test Conditions		Value		Unit
			Min.	Тур.	Max.	
t <sub>PLH</sub>	Propagation Delay Time, Low to High Level Output	$R_L = 3 \text{ to } 7 \text{ K}\Omega$ $C_L = 15 \text{ pF}$ (See Figures 3, 4)		315	500	ns
t <sub>PHL</sub>	Propagation Delay Time High to Low Level Output	$R_L = 3 \text{ to } 7 \text{ K}\Omega$ $C_L = 15 \text{ pF}$ (See Figures 3, 4)		75	175	ns
t <sub>TLH</sub>	Transition Time Low to High Level Output	$R_L = 3 \text{ to } 7 \text{ K}\Omega$ $C_L = 15 \text{ pF}$ (See Figures 3, 4)		60	100	ns
		$R_L = 3 \text{ to } 7 \text{ K}\Omega$ $C_L = 2500 \text{ pF}$ (Note 6, See Figure 3, 4)		1.7	2.5	μs
t <sub>THL</sub>	Transition Time High to Low Level Output	$R_L = 3 \text{ to } 7 \text{ K}\Omega$ $C_L = 15 \text{ pF}$ (See Figure 3, 4)		40	7.5	ns
		$R_L = 3 \text{ to } 7 \text{ K}\Omega$ $C_L = 2500 \text{ pF}$ (Note 6, See Figure 3, 4)		1.5	2.5	μs

NOTE 6: Measured between -3V and 3V points of output waveform (EIA-232-E conditions), all unused inputs are tied.

#### RECEIVER ELECTRICAL CHARACTERISTICS OVER OPERATING CONDITIONS

Symbol	Parameter	Test Conditions			Value		Unit
				Min.	Тур.	Max.	
$V_{T+}$	Positive Going Threshold Voltage	(See Figure 6)			2.2	2.4	V
V <sub>T</sub> -	Negative Going Threshold Voltage	$T_A = 25$ °C (See	Figure 6)	0.75	0.97		V
V <sub>hys</sub>	Input Hysteresis (V <sub>T+</sub> - V <sub>T-</sub> )			0.5			V
V <sub>OH</sub>	High Level Output Voltage	I <sub>OH</sub> = -0.5mA	V <sub>IH</sub> = 0.75 V	2.6	4	5	V
			Inputs Open	2.6			V
V <sub>OL</sub>	Low Level Output Voltage	V <sub>I</sub> = 3 V I <sub>OL</sub> = 1	0 mA		0.2	0.45	V
I <sub>IH</sub>	High Level Input Current	V <sub>I</sub> = 25 V (See	Figure 6)	3.6		8.3	mA
		$V_I = 3 V$ (See	Figure 6)	0.43			
I <sub>IL</sub>	Low Level Input Current	V <sub>I</sub> = -25 V (See	Figure 6)	-3.6		-8.3	mA
		V <sub>I</sub> = -3 V (See Figure 6)		-0.43			
I <sub>OS</sub>	Short-Circuit Output Current	$V_I = 0 V V_O = $ (See Figure 5)	0 V		-3.4	-12	mA

All typical values are at  $T_A = 25$  °C,  $V_{CC} = 5V$ ,  $V_{DD} = 9V$  and  $V_{SS} = -9V$ 

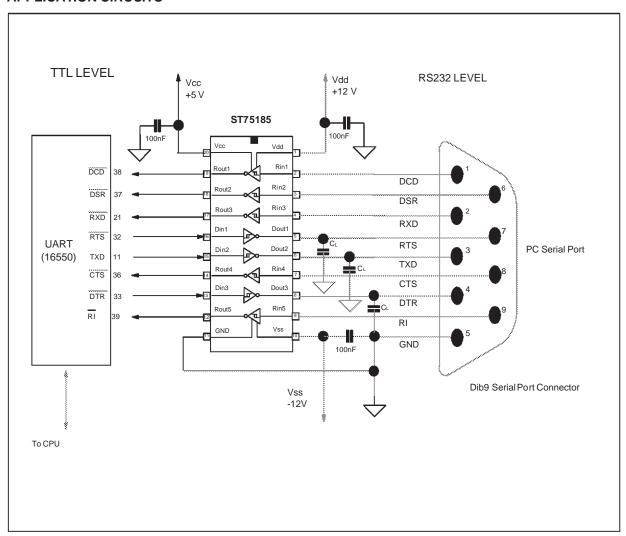
#### RECEIVER SWITCHING CHARACTERISTICS

 $(V_{DD} = 12V, V_{SS} = -12V, V_{CC} = 5V T_A = 25 ^{\circ}C)$ 

Symbol	Parameter	Test Conditions	Value		Unit	
			Min.	Тур.	Max.	
t <sub>PLH</sub>	Propagation Delay Time, Low to High Level Output	$R_L = 5 \text{ K}\Omega$ $C_L = 50 \text{ pF}$ (See Figure 6)		400	1000	ns
t <sub>PHL</sub>	Propagation Delay Time High to Low Level Output	$R_L = 5 \text{ K}\Omega$ $C_L = 50 \text{ pF}$ (See Figure 6)		70	150	ns
t <sub>TLH</sub>	Transition Time Low to High Level Output	$R_L = 5 \text{ K}\Omega$ $C_L = 50 \text{ pF}$ (See Figure 6)		200	525	ns
t <sub>THL</sub>	Transition Time High to Low Level Output	$R_L = 5 \text{ K}\Omega$ $C_L = 50 \text{ pF}$ (See Figure 6)		20	60	ns



#### **APPLICATION CIRCUITS**



**FIGURE 1:** Driver Test Circuit for  $V_{OH},\ V_{OL},\ I_{SO(H)}$  and  $I_{SO(L)}$ 

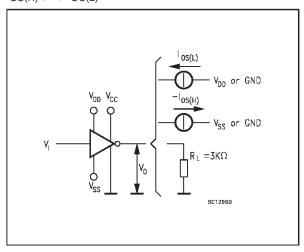
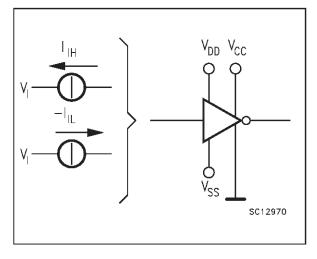


FIGURE 2: Driver Test Circuitfor I<sub>IH</sub> and I<sub>IL</sub>



6/12

FIGURE 3: Driver Test Circuit

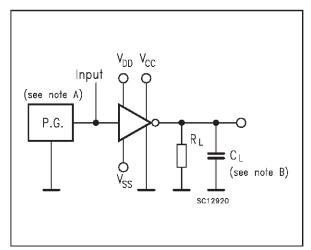


FIGURE 4: Driver Voltage Waveforms

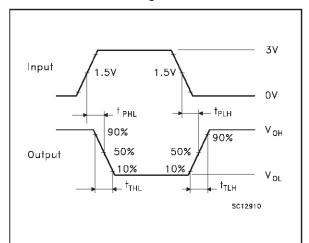


FIGURE 5: Receiver Test Circuit for Ios

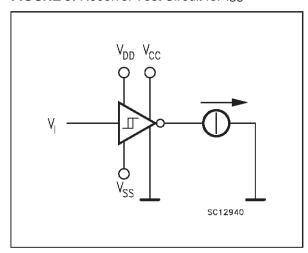


FIGURE 6: Receiver Test Circuit for V<sub>T</sub>, V<sub>OH</sub>, V<sub>OL</sub>

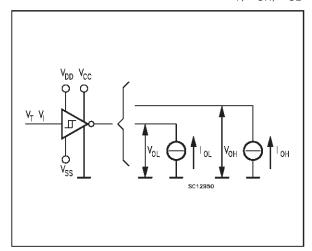


FIGURE 7: Receiver Test Circuit

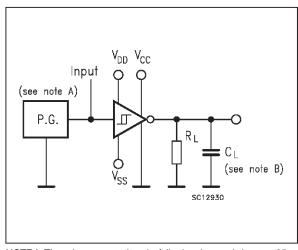
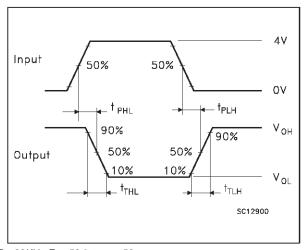


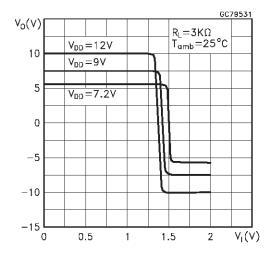
FIGURE 8: Receiver Voltage Waveforms



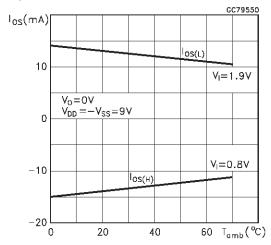
NOTE A: The pulse generator has the following characteristics:  $t_W$  = 25  $\mu$ s, PRR = 20 KHz,  $Z_0$  = 50  $\Omega$ ,  $t_r$  =  $t_f$  < 50ns. NOTE B:  $C_L$  includes probe and jig capacitance.

57

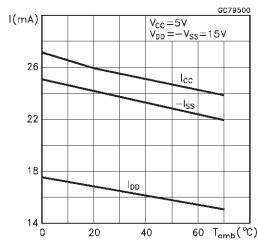
#### **Driver Voltage Transfer Characteristics**



# Driver Short Circuit Output Current vs Free-Air Temperature

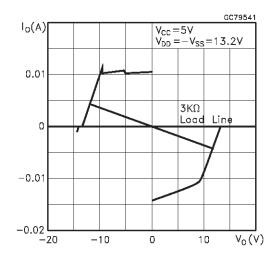


#### **Device Supply Current vs Temperature**

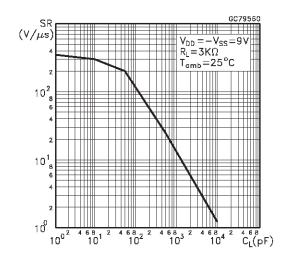


8/12

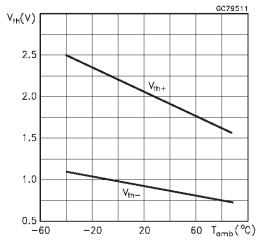
#### Driver Output Current vs Output Voltage



#### Driver Output Slew Rate vs Load Capacitance

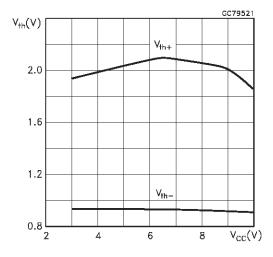


#### Receiver Threshold vs Temperature



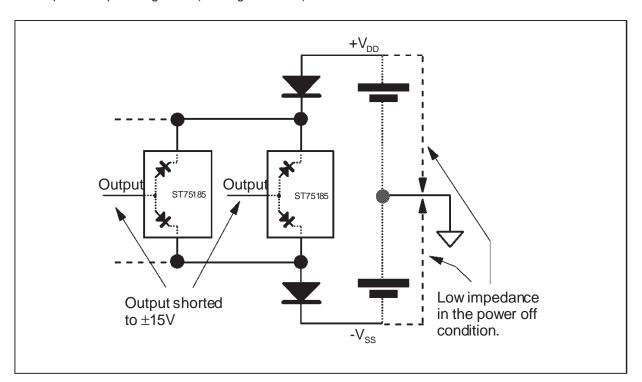
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#### Receiver Threshold vs Supply Voltage



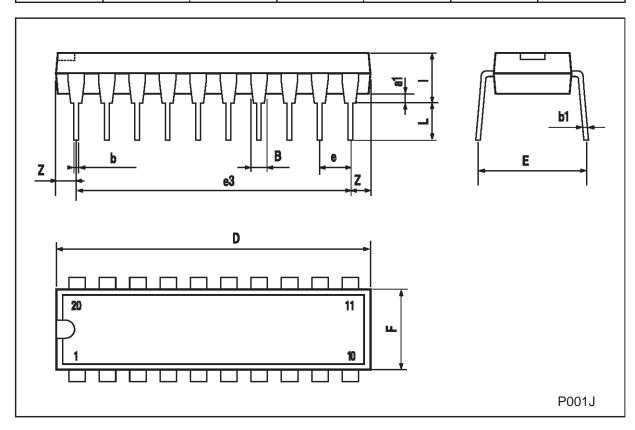
#### APPLICATION INFORMATION: DIODES ON POWER SUPPLY

Diodes placed in series with the  $V_{DD}$  and  $V_{SS}$  leads protect the ST75185 in the fault condition in which the devices output are shorted to  $\pm 15V$  and the power supplies are at low state and provide low-impedance path to ground (see Figure below)



# Plastic DIP-20 (0.25) MECHANICAL DATA

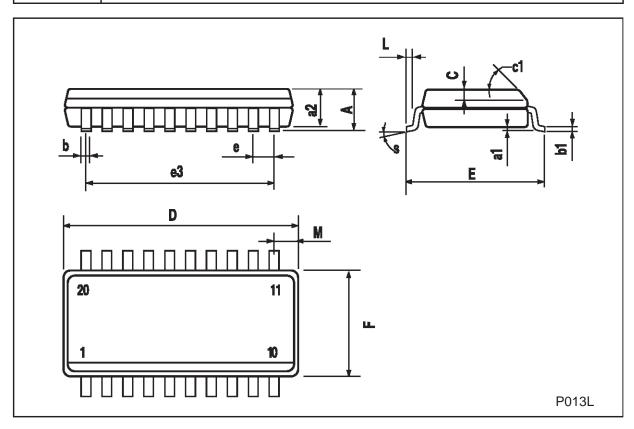
DIM.	DIM. mm				inch	
Jiiii.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.254			0.010		
В	1.39		1.65	0.055		0.065
b		0.45			0.018	
b1		0.25			0.010	
D			25.4			1.000
Е		8.5			0.335	
е		2.54			0.100	
e3		22.86			0.900	
F			7.1			0.280
1			3.93			0.155
L		3.3			0.130	
Z			1.34			0.053



**47** 

## **SO-20 MECHANICAL DATA**

DIM.		mm			inch	
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			2.65			0.104
a1	0.10		0.20	0.004		0.007
a2			2.45			0.096
b	0.35		0.49	0.013		0.019
b1	0.23		0.32	0.009		0.012
С		0.50			0.020	
c1			45	(typ.)		
D	12.60		13.00	0.496		0.512
Е	10.00		10.65	0.393		0.419
е		1.27			0.050	
e3		11.43			0.450	
F	7.40		7.60	0.291		0.299
L	0.50		1.27	0.19		0.050
М			0.75			0.029
S			8 (r	max.)		



**577** 

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5/